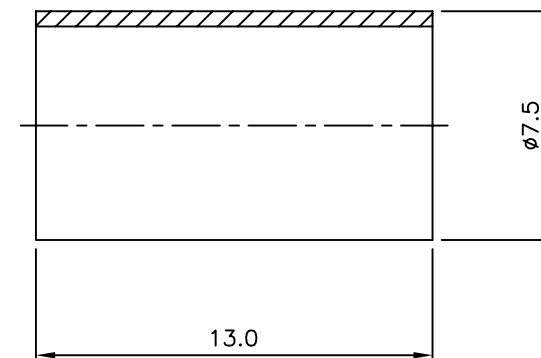
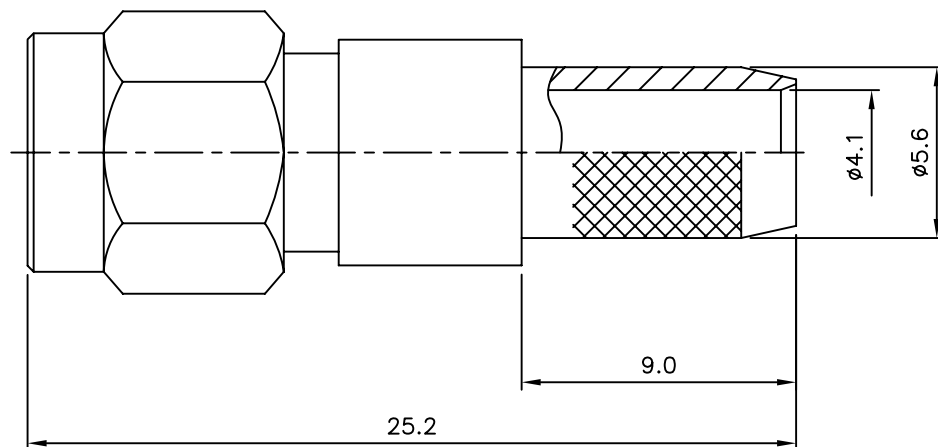
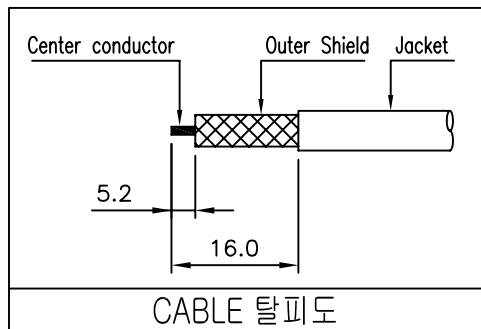


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2013.02.15.
1	[설변처리No.201609-0008] 도금사양 변경 (두께도금->후레쉬)	I.C.KIM		2016.09.20.



ELECTRICAL DATA :

1. IMPEDANCE : 50ohm
2. FREQUENCY RANGE : DC~6GHz
3. VSWR (Max) : 1.2



7	SPRING RING	1	SUS	부동태처리	DSR00002-5/1
6	CAP	1	MBsBD	Nickel Plate	DCU00005-5/2 DCU00005-5/6
5	GASKET	1	SILICONE RUB		DGK00004-N/1
4	INSULATOR	1	TEFLON		DIN00093-N/1
3	FERRULE	1	MBsBD	Nickel Plate	DFE00062-5/2
2	CONTACT	1	MBsBD	Gold Plate	DCT00281-5/1 DCT00281-5/2
1	BODY	1	MBsBD	Nickel Plate	DBD00132-5/1 DBD00132-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			2016. 09. 20.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	±0.3	APPROVED BY								
	Angle									
MATERIAL	±1°	CHECKED BY				TITLE	SMA50 CABLE PS LMR240			
	-	DRAWN BY	I.C.KIM							
FINISH	-	SCALE	4/1	UNIT	mm		A4	DWG NO.	CN00959-7/3	
								REVISION	1	SHEET